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TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT (Under 37 CFR 1.97(b) or 1.97(c))			Docket No. 08228-019001	
In Re Application Of: Shiro SAKAI et al.				
Serial No. 10/044,686	Filing Date 01/11/2002	Examiner	Group Art Unit 1765	
Title: NITRIDE SEMICONDUCTOR CHIP AND METHOD FOR MANUFACTURING NITRIDE SEMICONDUCTOR CHIP				
<p>Address to: Assistant Commissioner for Patents Washington, D.C. 20231</p> <p>37 CFR 1.97(b)</p> <p>1. <input checked="" type="checkbox"/> The Information Disclosure Statement submitted herewith is being filed within three months of the filing of a national application; within three months of the date of entry of the national stage as set forth in 37 CFR 1.491 in an international application; or before the mailing date of a first Office Action on the merits, whichever event occurs last.</p> <p>37 CFR 1.97(c)</p> <p>2. <input type="checkbox"/> The Information Disclosure Statement submitted herewith is being filed after three months of the filing of a national application, or the date of entry of the national stage as set forth in 37 CFR 1.491 in an international application; or after the mailing date of a first Office Action on the merits, whichever occurred last but before the mailing date of either:</p> <p>1. a Final Action under 37 CFR 1.113, or</p> <p>2. a Notice of Allowance under 37 CFR 1.311,</p> <p>whichever occurs first.</p> <p>Also submitted herewith is:</p> <p><input type="checkbox"/> a certification as specified in 37 CFR 1.97(e);</p> <p>OR</p> <p><input type="checkbox"/> the fee set forth in 37 CFR 1.17(p) for submission of an Information Disclosure Statement under 37 CFR 1.97(c).</p>				

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Docket No.

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In Re Application Of: Shiro SAKAI et al.

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Title: NITRIDE SEMICONDUCTOR CHIP AND METHOD FOR MANUFACTURING NITRIDE
SEMICONDUCTOR CHIP**Payment of Fee**

(Only complete if Applicant elects to pay the fee set forth in 37 CFR 1.17(p))

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CERTIFICATE OF MAILING BY "EXPRESS MAIL" (37 CFR 1.10) Applicant(s): Shiro SAKAI et al.		Docket No. 08228-019001	
Serial No. 10/044,686	Filing Date 01/11/2002	Examiner FEB 06 2003	Group Art Unit 1765
Invention: NITRIDE SEMICONDUCTOR CHIP AND METHOD FOR MANUFACTURING NITRIDE SEMICONDUCTOR CHIP			
<p>I hereby certify that this <u>Information Disclosure Statement and PTO Form 1449</u> (Identify type of correspondence)</p> <p>is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 in an envelope addressed to: The Commissioner of Patents and Trademarks, Washington, D.C. 20231-0001 on <u>2/6/03</u> (Date)</p> <p><u>Denise Blocker</u> (Typed or Printed Name of Person Mailing Correspondence)</p> <p><u></u> (Signature of Person Mailing Correspondence)</p> <p><u>EV245366449US</u> ("Express Mail" Mailing Label Number)</p>			
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INFORMATION DISCLOSURE CITATION

(Use several sheets if necessary)

Docket Number (Optional)

08228-019001

Application Number

10/044,686

Applicant(s)

Shiro SAKAI et al.

Filing Date

01/11/2002

Group Art Unit

1765

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	A1	3,909,929	10/07/1975	Debasis	29	590	
	A2	5,786,233	07/28/1998	Taskar et al.	438	46	
	A3	6,242,328	06/05/2001	Shin	438	518	

FOREIGN PATENT DOCUMENTS

	REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
							YES	NO
	B1	EP 0 180 222 A2	05/07/1986	EPO	H01L	31/18		
	B2	EP 0 180 222 A3	05/07/1986	EPO	H01L	21/308		
	B3	EP 0 723 303 A2	07/24/1996	EPO	H01L	33/00		
	B4	EP 0 723 303 A3	05/28/1997	EPO	H01L	33/00		
	B5	EP 0 731 490 A2	09/11/1996	EPO	H01L	21/033		

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

C1	Patent Abstracts of Japan, Publication No. 07097300, Publication Date 04/11/1995, 1 page
C2	Patent Abstracts of Japan, Publication No. 10178213, Publication Date 06/30/1998, 1 page

EXAMINER

DATE CONSIDERED

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.



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01/11/2002

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